

20 V, 3.7 A / 320 mV VF P-channel MOSFET-Schottky combination

21 December 2012

**Product data sheet** 

### 1. General description

Small-signal P-channel enhancement mode Field-Effect Transistor (FET) using Trench MOSFET technology and ultra low V<sub>F</sub> Maximum Efficiency General Application (MEGA) Schottky diode combined in a small and leadless ultra thin DFN2020-6 (SOT1118) Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

- 1.8 V R<sub>DSon</sub> rated for low-voltage gate drive
- Small and leadless ultra thin SMD plastic package: 2 × 2 × 0.65 mm
- Exposed drain pad for excellent thermal conduction
- Integrated ultra low V<sub>F</sub> MEGA Schottky diode

### 3. Applications

- Charging switch for portable devices
- DC-to-DC converters
- Power management in battery-driven portables
- · Hard disk and computing power management

### 4. Quick reference data

Table 1.         Quick reference data								
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit	
MOSFET tra	nsistor							
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	-20	V	
V <sub>GS</sub>	gate-source voltage	_		-12	-	12	V	
I <sub>D</sub>	drain current	$V_{GS}$ = -4.5 V; $T_{amb}$ = 25 °C; t ≤ 5 s	[1]	-	-	-3.7	А	
Schottky dio	de						_	
l <sub>F</sub>	forward current	T <sub>sp</sub> ≤ 105 °C		-	-	2	А	
V <sub>R</sub>	reverse voltage	T <sub>amb</sub> = 25 °C		-	-	20	V	
MOSFET tra	MOSFET transistor static characteristics							
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -2.7 A; T <sub>j</sub> = 25 °C		-	80	102	mΩ	

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Schottky diode	9					
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C	-	320	365	mV

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 cm<sup>2</sup>.

### 5. Pinning information

Table 2.	Pinning	information					
Pin	Symbol	Description	Simplified outline	Graphic symbol			
1	А	anode	6 5 4	A G S			
2	n.c.	not connected					
3	D	drain	7 8				
4	S	source					
5	G	gate					
6	к	cathode	Transparent top view DFN2020-6 (SOT1118)	K D aaa-003667			
7	К	cathode	21112020 3 (0011110)	222-003007			
8	D	drain					

### 6. Ordering information

Table 3. Ordering information								
Type number	Package							
	Name	Description	Version					
PMFPB8032XP	DFN2020-6	plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals; body $2 \times 2 \times 0.65$ mm	SOT1118					

### 7. Marking

Table 4. Marking codes					
	Type number	Marking code			
	PMFPB8032XP	1X			

### 8. Limiting values

#### Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter		Conditions	Min	Мах	Unit
MOSFET tran	isistor					
V <sub>DS</sub>	drain-source voltage		T <sub>j</sub> = 25 °C	-	-20	V
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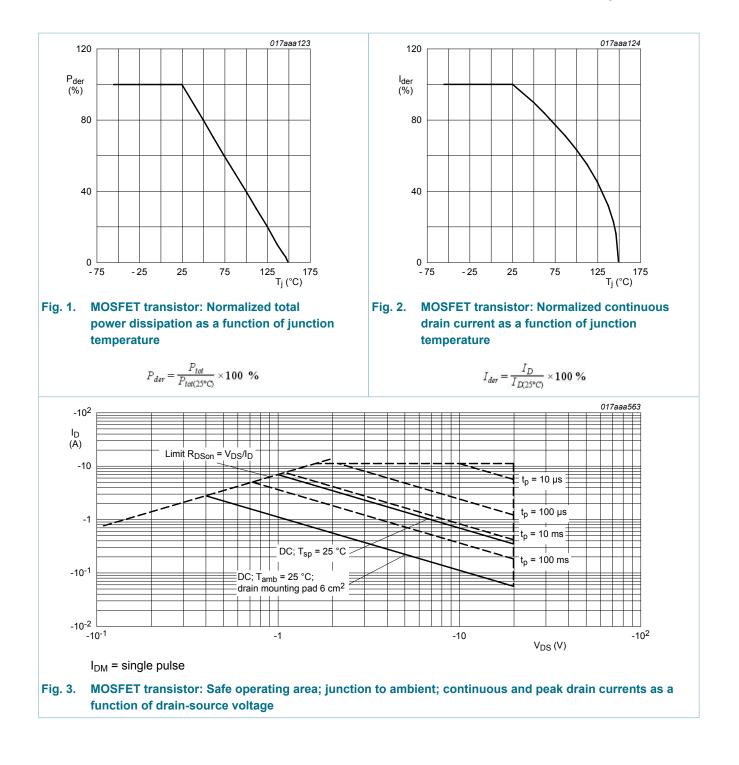
Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>GS</sub>	gate-source voltage			-12	12	V
I <sub>D</sub>	drain current	$V_{GS}$ = -4.5 V; $T_{amb}$ = 25 °C; t ≤ 5 s	[1]	-	-3.7	А
		V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C	[1]	-	-2.7	Α
		V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 100 °C	[1]	-	-1.7	Α
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-11	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	485	mW
			[1]	-	1100	mW
		T <sub>sp</sub> = 25 °C		-	6250	mW
Source-dra	ain diode					_,
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	-1.1	А
Schottky d	liode	l				
V <sub>R</sub>	reverse voltage	T <sub>amb</sub> = 25 °C		-	20	V
I <sub>F</sub>	forward current	T <sub>sp</sub> ≤ 105 °C		-	2	А
I <sub>FRM</sub>	repetitive peak forward current	$t_p \le 1 \text{ ms}; \delta \le 0.25; T_{amb} = 25 \text{ °C}$		-	7	А
I <sub>FSM</sub>	non-repetitive peak forward	$t_p$ = 8 ms; $T_{j(init)}$ = 25 °C; square wave		-	18	А
	current	$t_p$ = 8 ms; $T_{j(init)}$ = 25 °C; half-sine wave	[3]	-	25	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	480	mW
			[1]	-	1190	mW
		T <sub>sp</sub> = 25 °C		-	6250	mW
Per device						_
Tj	junction temperature			-55	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 cm<sup>2</sup>. Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint. [1]

[2]

Calculated from square-wave measurements. [3]

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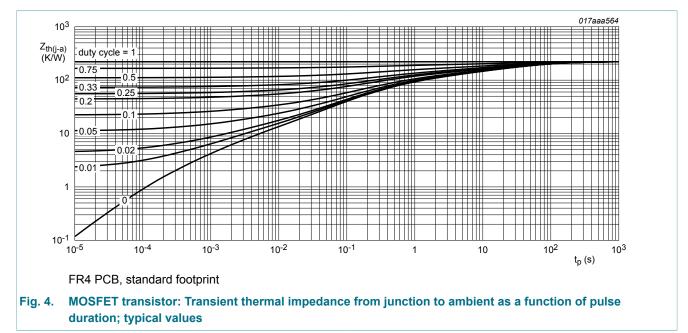


#### 9. Thermal characteristics

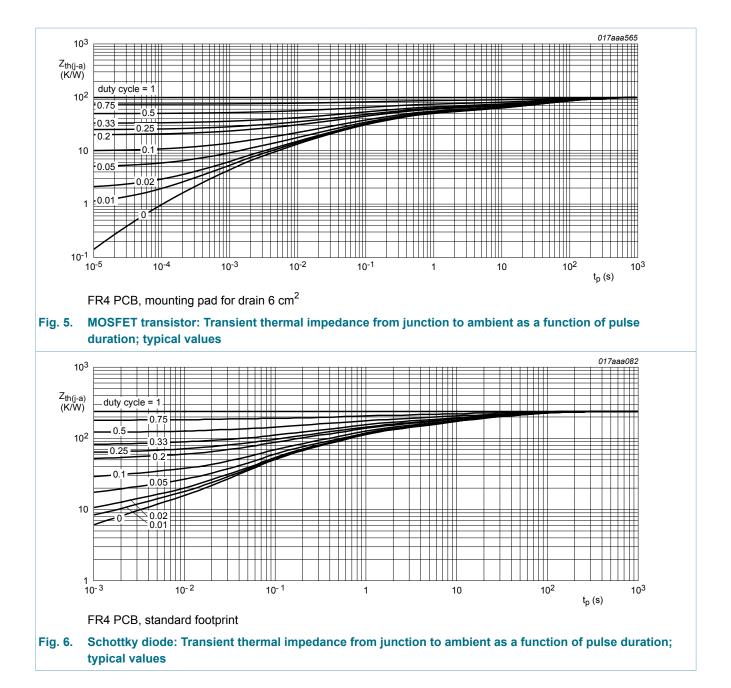
0	B				-		11.14
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
MOSFET tra	insistor						
R <sub>th(j-a)</sub>	thermal resistance	in free air	[1]	-	225	260	K/W
	from junction to		[2]	-	99	115	K/W
ambient		in free air; t ≤ 5 s	[2]	-	54	62	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	16	20	K/W
Schottky die	ode	1					
R <sub>th(j-a)</sub>	thermal resistance	in free air	[1]	-	-	260	K/W
	from junction to ambient		[2]	-	-	105	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	-	20	K/W

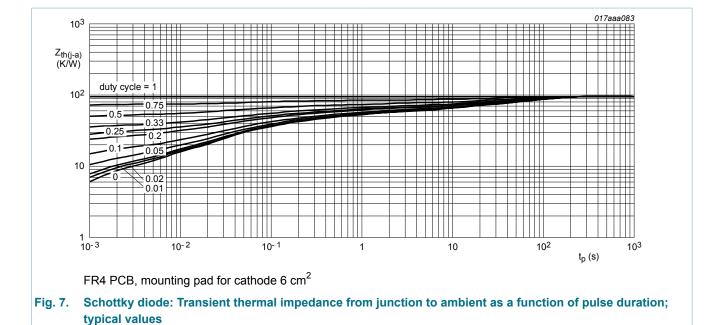
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 cm<sup>2</sup>.



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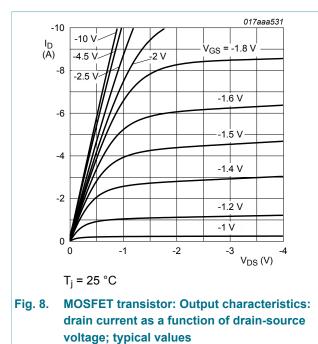
### **10. Characteristics**

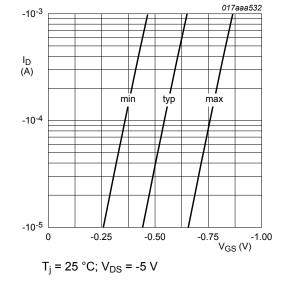
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
MOSFET tra	ansistor static characteris	tics				
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	I <sub>D</sub> = -250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-20	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	$I_D$ = -250 µA; $V_{DS}$ = $V_{GS}$ ; $T_j$ = 25 °C	-0.4	-0.6	-1	V
I <sub>DSS</sub> drain leakage current	$V_{DS}$ = -20 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-	-	-1	μA	
		V <sub>DS</sub> = -20 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 150 °C	-	-	-10	μA
I <sub>GSS</sub> gate leakage current	$V_{GS}$ = -12 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	-100	nA	
		$V_{GS}$ = 12 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = -4.5 V; I <sub>D</sub> = -2.7 A; T <sub>j</sub> = 25 °C	-	80	102	mΩ
		$V_{GS}$ = -4.5 V; I <sub>D</sub> = -2.7 A; T <sub>j</sub> = 150 °C	-	116	148	mΩ
		$V_{GS}$ = -2.5 V; I <sub>D</sub> = -2.5 A; T <sub>j</sub> = 25 °C	-	95	125	mΩ
		V <sub>GS</sub> = -1.8 V; I <sub>D</sub> = -1.1 A; T <sub>j</sub> = 25 °C	-	120	156	mΩ
9 <sub>fs</sub>	transfer conductance	V <sub>DS</sub> = -10 V; I <sub>D</sub> = -2.7 A; T <sub>j</sub> = 25 °C	-	15	-	S
MOSFET tra	ansistor dynamic characte	ristics	I			
Q <sub>G(tot)</sub>	total gate charge	$V_{DS}$ = -10 V; I <sub>D</sub> = -2.7 A; V <sub>GS</sub> = -4.5 V;	-	5.7	8.6	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C	-	0.7	-	nC
Q <sub>GD</sub>	gate-drain charge		-	0.96	-	nC

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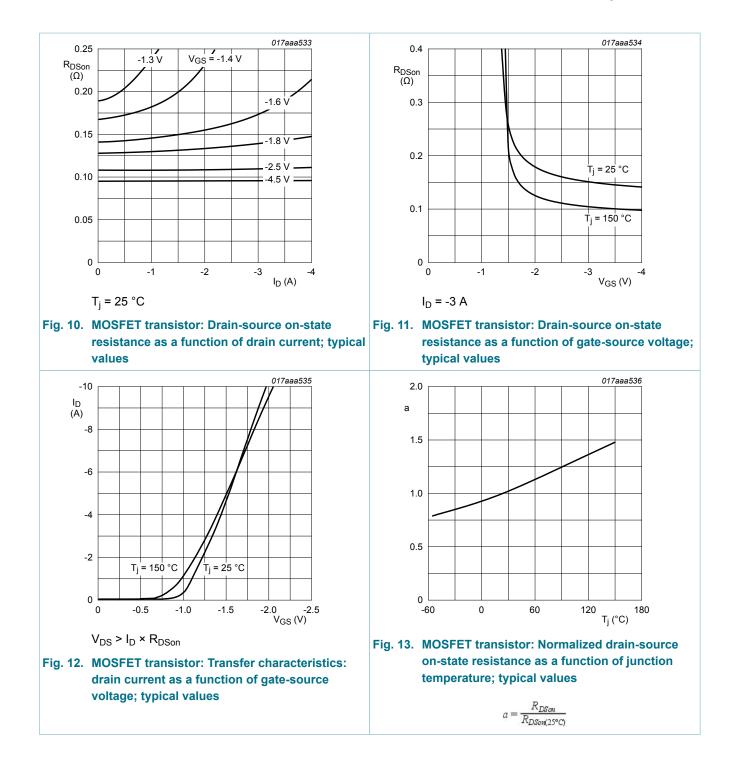
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
C <sub>iss</sub>	input capacitance	$V_{DS}$ = -10 V; f = 1 MHz; $V_{GS}$ = 0 V;	-	550	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	63	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	53	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = -10 V; $I_D$ = -2.4 A; $V_{GS}$ = -4.5 V;	-	6	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	14	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	120	-	ns
t <sub>f</sub>	fall time		-	50	-	ns
MOSFET tra	ansistor source-drain dio	de	I		1	
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = -1.1 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-0.8	-1.2	V
Schottky di	iode					
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 100 mA; T <sub>j</sub> = 25 °C	-	225	275	mV
		I <sub>F</sub> = 500 mA; T <sub>j</sub> = 25 °C	-	285	335	mV
		I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C	-	320	365	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 5 V; T <sub>j</sub> = 25 °C	-	65	220	μA
		V <sub>R</sub> = 5 V; T <sub>j</sub> = 125 °C	-	13	50	mA
		V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C	-	110	400	μA
		V <sub>R</sub> = 20 V; T <sub>j</sub> = 25 °C	-	230	700	μA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 5 V; f = 1 MHz; T <sub>i</sub> = 25 °C	-	60	70	pF







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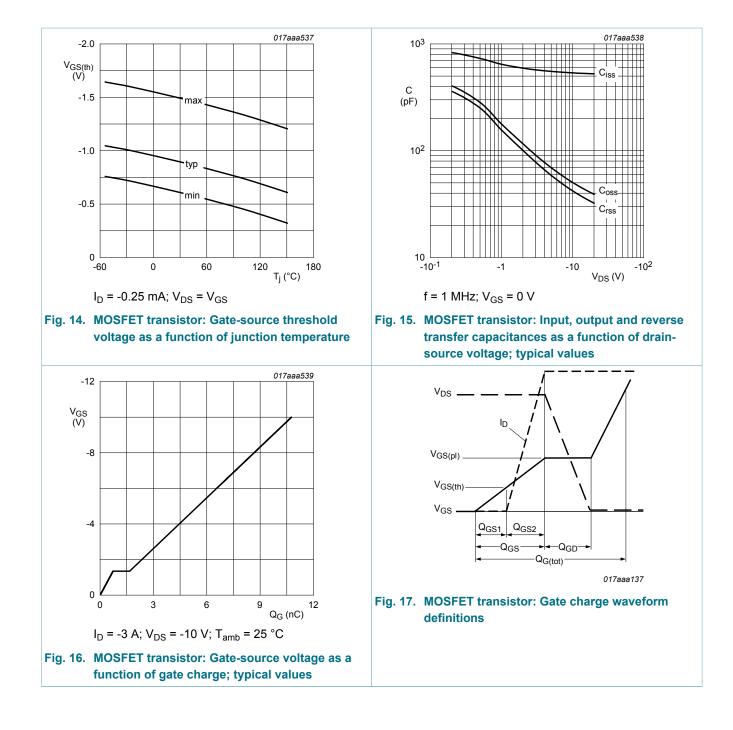


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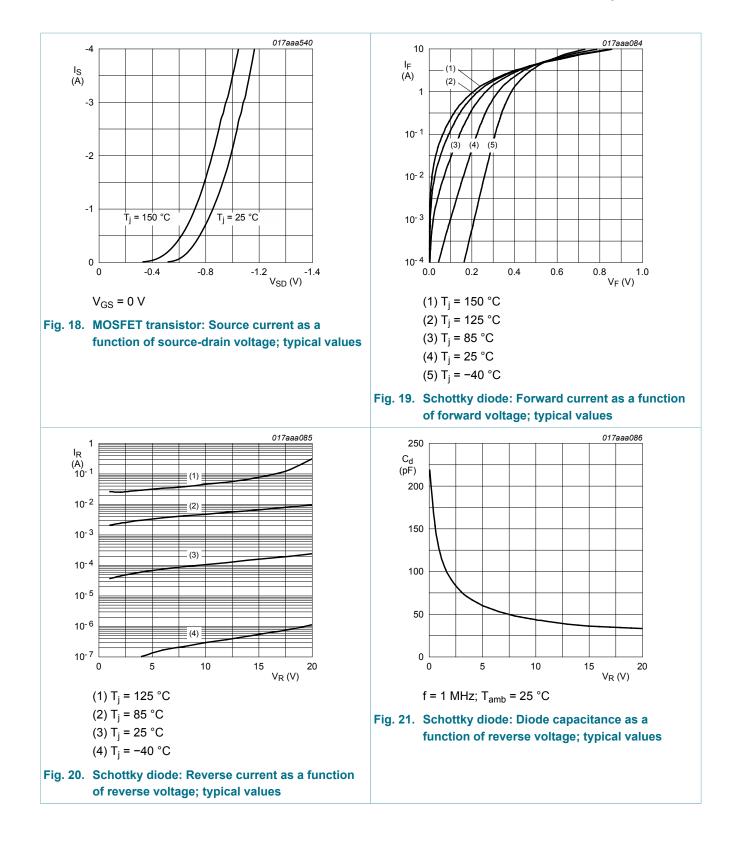
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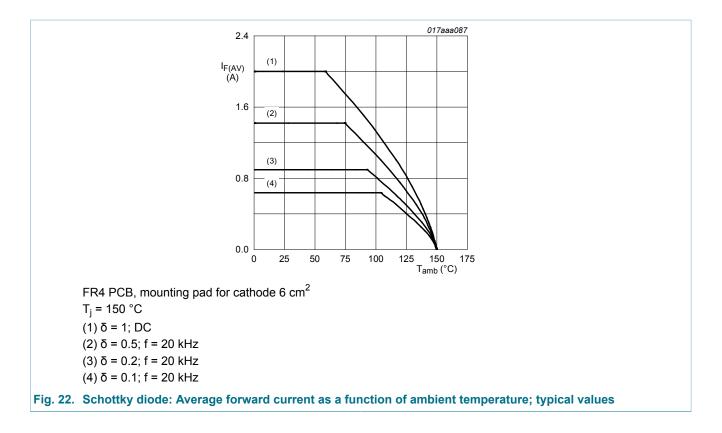


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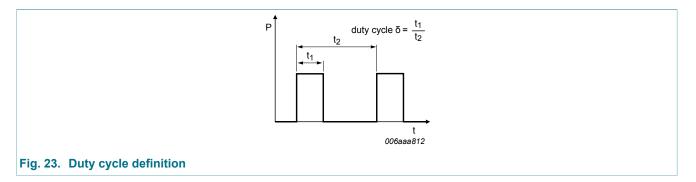
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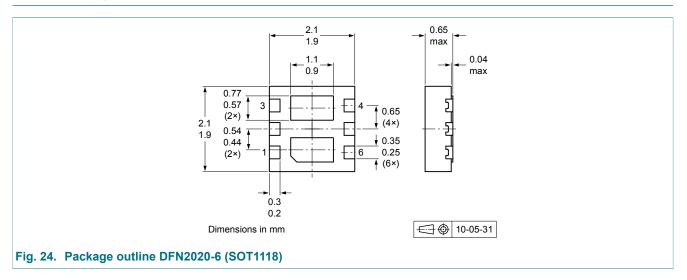
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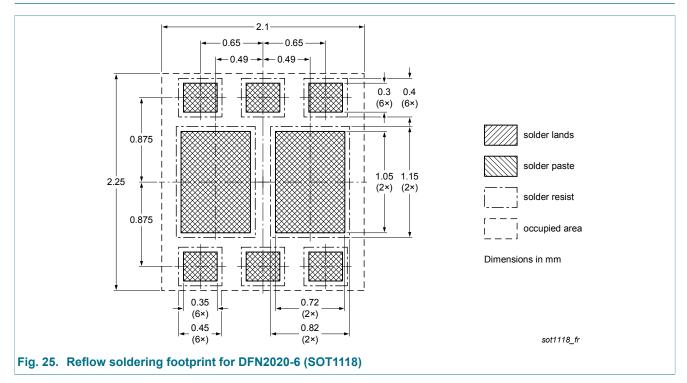
### 11. Test information



### 12. Package outline



### 13. Soldering



### 14. Revision history

Table 8. Revision hi	story			
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMFPB8032XP v.1	20121221	Product data sheet	-	-
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Product data sheet		21 December 2012		13 / 16

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